

## Description

The VSM12P06 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## General Features

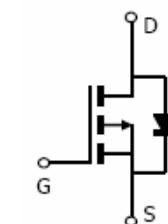
- $V_{DS} = -60V, I_D = -12A$
- $R_{DS(ON)} < 14m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} < 17m\Omega @ V_{GS} = -4.5V$
- High density cell design for ultra low  $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

## Application

- Power switching application
- Hard switched and high frequency circuits
- DC-DC Converter



SOP-8



Schematic Diagram

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM12P06-S8	VSM12P06	SOP-8	Ø330mm	12mm	4000 units

## Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	-60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	-12	A
Drain Current-Continuous( $T_C=100^\circ C$ )	$I_D (100^\circ C)$	-8.5	A
Pulsed Drain Current	$I_{DM}$	-50	A
Maximum Power Dissipation	$P_D$	3.5	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C

## Thermal Characteristic

Thermal Resistance ,Junction-to-Ambient <sup>(Note 2)</sup>	$R_{\theta JA}$	35	°C/W
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**Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

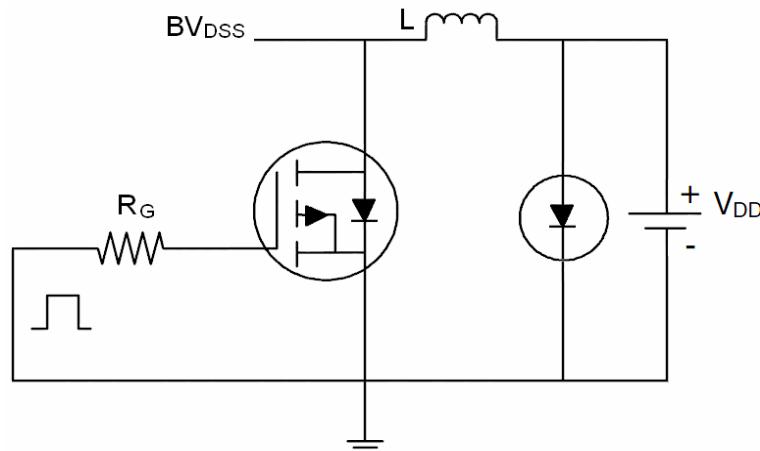
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-60	-	-	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=-60\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
<b>On Characteristics</b> <small>(Note 3)</small>						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$	-1.2	-1.8	-2.5	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-12\text{A}$	-	11	14	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-12\text{A}$	-	13	17	$\text{m}\Omega$
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-12\text{A}$	-	40	-	S
<b>Dynamic Characteristics</b> <small>(Note 4)</small>						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=-30\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$	-	5604	-	PF
Output Capacitance	$\text{C}_{\text{oss}}$		-	356	-	PF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	265	-	PF
<b>Switching Characteristics</b> <small>(Note 4)</small>						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=-30\text{V}, \text{R}_{\text{L}}=2.5\Omega$ $\text{V}_{\text{GS}}=-10\text{V}, \text{R}_{\text{GEN}}=6\Omega$	-	16	-	nS
Turn-on Rise Time	$t_r$		-	18	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	50	-	nS
Turn-Off Fall Time	$t_f$		-	33	-	nS
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=-30\text{V}, \text{I}_D=-12\text{A},$ $\text{V}_{\text{GS}}=-10\text{V}$	-	62.1	-	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	9.3	-	nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	16.8	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <small>(Note 3)</small>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=-12\text{A}$	-	-	-1.2	V
Diode Forward Current <small>(Note 2)</small>	$\text{I}_s$		-	-	-12	A

**Notes:**

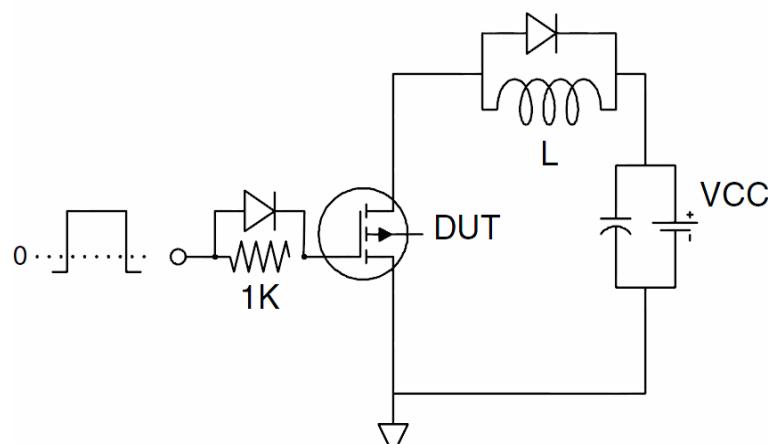
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

## Test Circuit

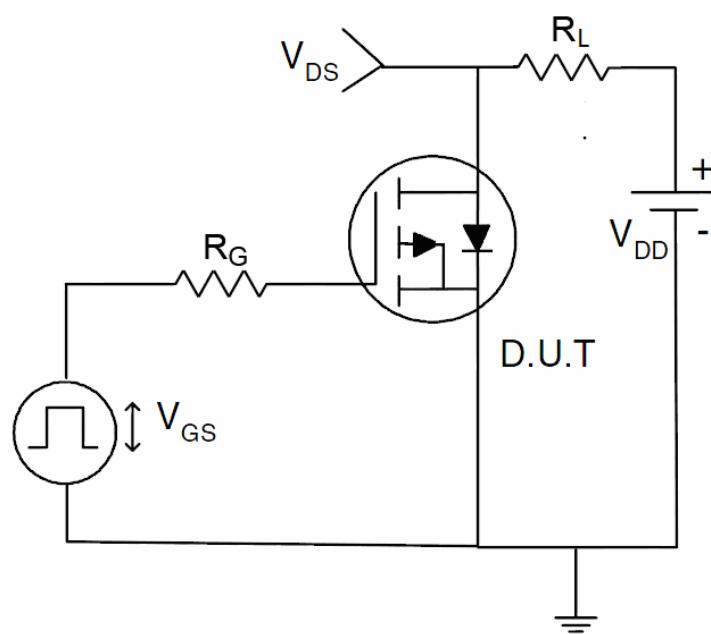
### 1) E<sub>AS</sub> Test Circuit



### 2) Gate Charge Test Circuit



### 3) Switch Time Test Circuit



### Typical Electrical and Thermal Characteristics

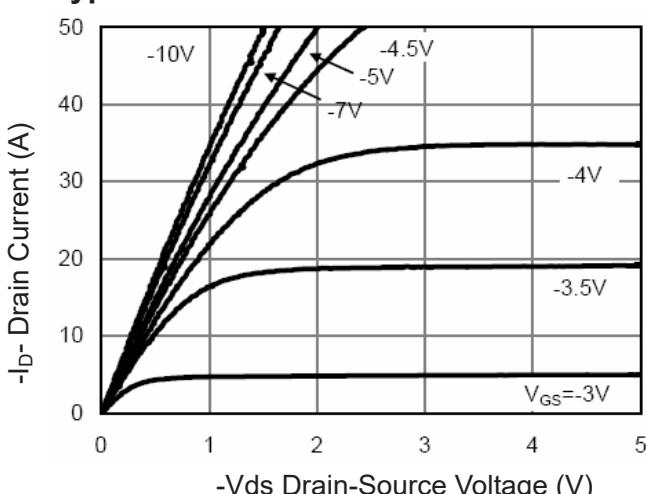


Figure 1 Output Characteristics

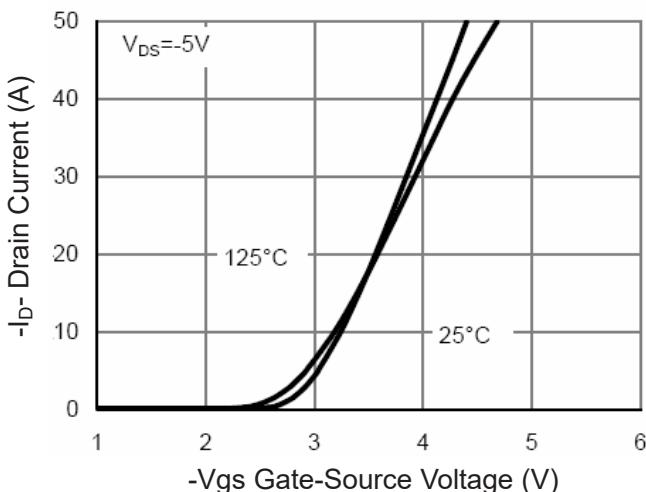


Figure 2 Transfer Characteristics

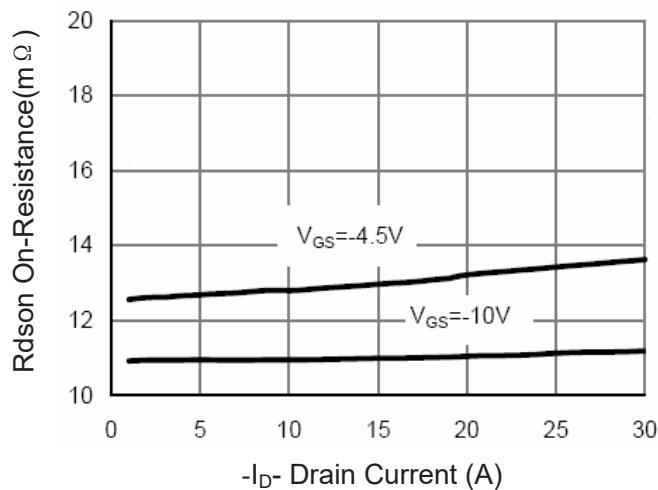


Figure 3 Rdson- Drain Current

### (Curves)

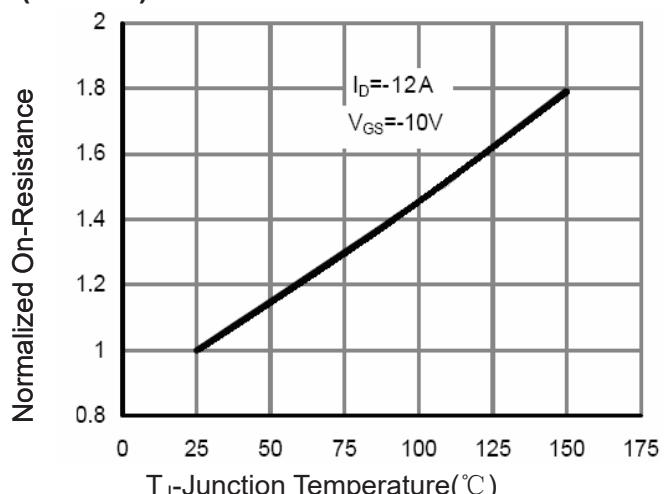


Figure 4 Rdson-Junction Temperature

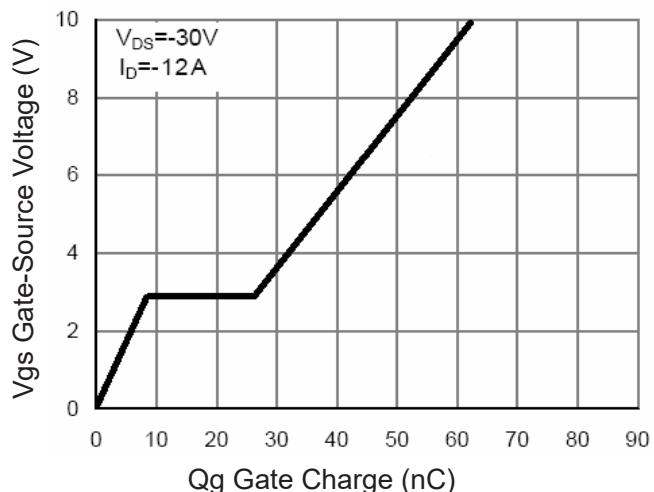


Figure 5 Gate Charge

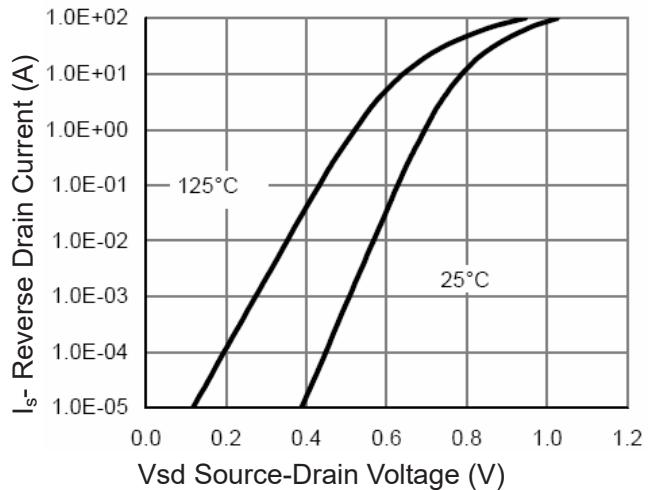
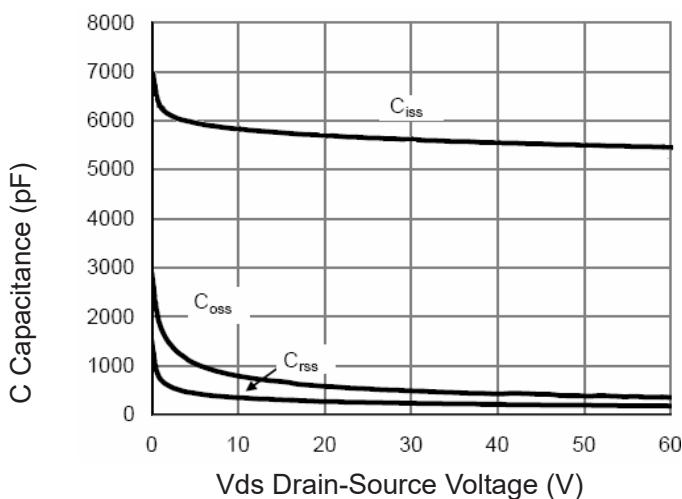
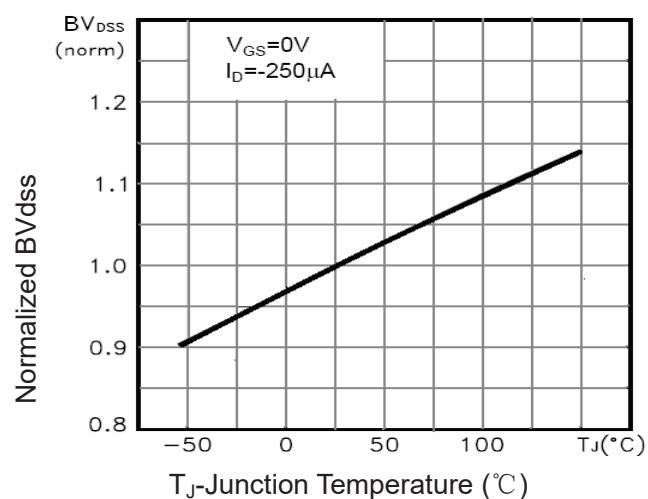
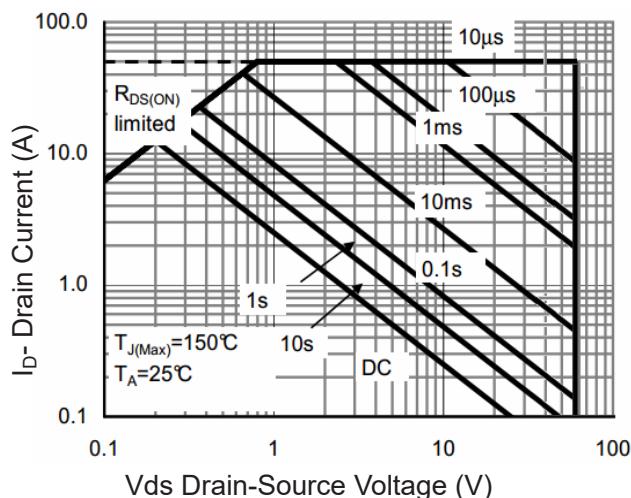
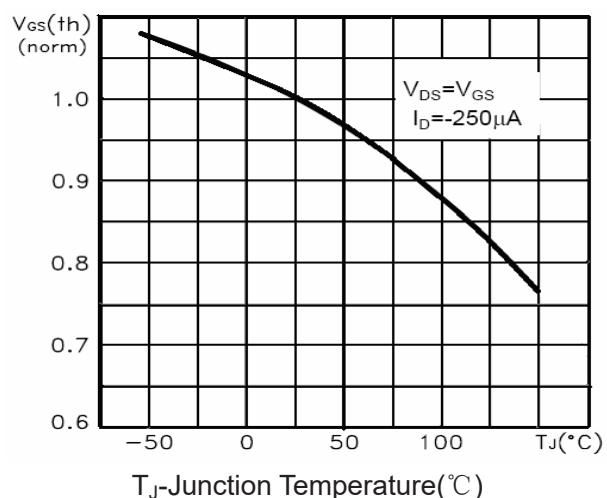
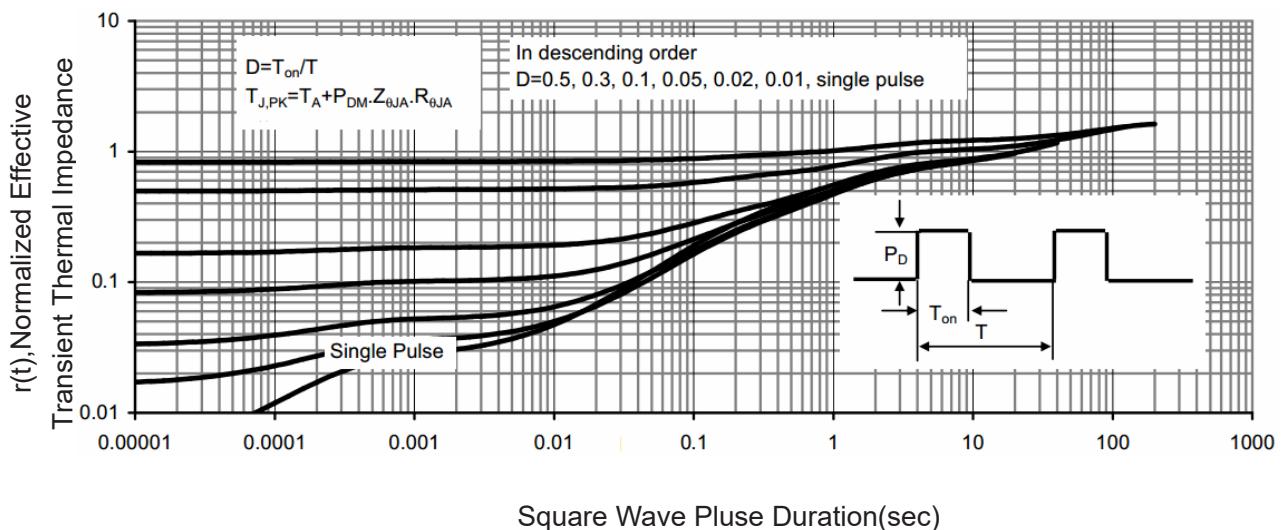


Figure 6 Source- Drain Diode Forward


**Figure 7 Capacitance vs Vds**

**Figure 9  $BV_{dss}$  vs Junction Temperature**

**Figure 8 Safe Operation Area**

**Figure 10  $V_{GS(\text{th})}$  vs Junction Temperature**

**Figure 11 Normalized Maximum Transient Thermal Impedance**